

101 Element Bar Graph Array

Technical Data

**HDSP-8820
HDSP-8825
HDSP-8835**

Features

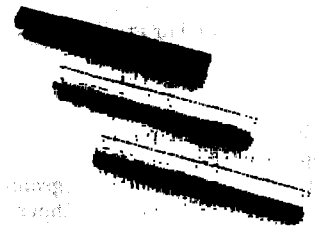
- **High Resolution (1%)**
- **Excellent Element Appearance**
Wide, Recognizable Elements
Matched LEDs for Uniformity
Excellent Element Alignment
- **Single-in-line Package Design**
Sturdy Leads on Industry Standard 2.54 mm (0.100 in.) Centers
Environmentally Rugged Package

Common Cathode Configuration

- **Low Power Requirements**
1.0 mA Average per Element at 1% Duty Cycle
- **Support Electronics**
Easy Interface with Microprocessors

Applications

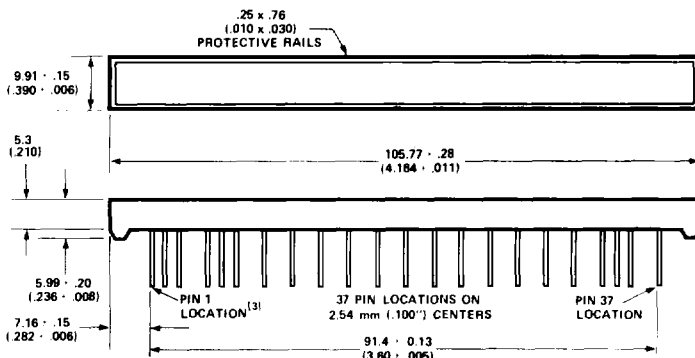
- **Industrial Process Control Systems**
- **Edgewise Panel Meters**
- **Instrumentation**
- **Position Indicators**
- **Fluid Level Indicators**



Description

The HDSP-88XX series is a family of 101-element LED linear arrays designed to display information in easily recognizable bar graph or position indicator form. The HDSP-8820, utilizing red GaAsP LED chips assembled on

Package Dimensions^[1, 2]

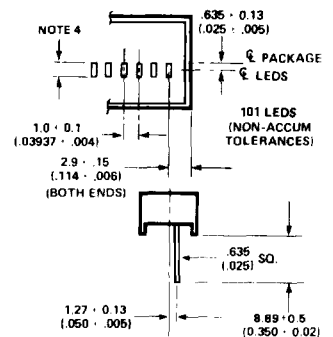


NOTES:

1. ALL DIMENSIONS IN MILLIMETRES AND (INCHES).
2. ALL UNTOLERANCED DIMENSIONS ARE FOR REFERENCE ONLY.
3. PIN 1 IDENTIFIED BY INK DOT ADJACENT TO LEAD AND HP PART NUMBER ON BACK OF PACKAGE.

4. SEGMENT WIDTH DIMENSION IS 1.52 mm (.060) FOR HDSP-8820 AND 1.02 mm (.040) FOR HDSP-8825 AND HDSP-8835. ALL OTHER DIMENSIONS INCLUDING CENTERLINE OF LED_S AND PACKAGE ARE IDENTICAL ON ALL 3 DEVICES.

MAGNIFIED ELEMENT DESCRIPTION

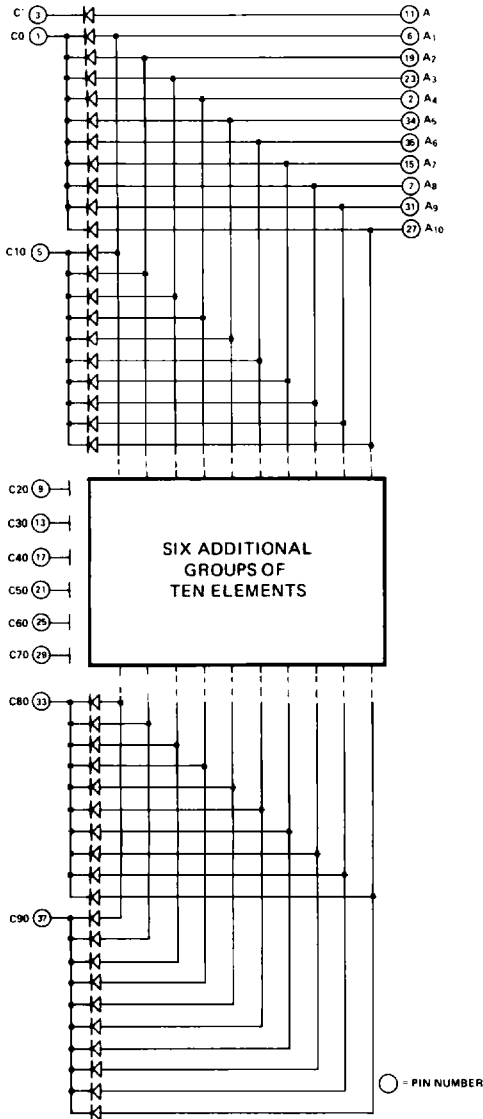


a PC board and enclosed in a red polycarbonate cover with an epoxy backfill seal, has 1.52 mm (0.060 inch) wide segments. The HDSP-8825 and HDSP-8835 are high efficiency red and high

performance green respectively, each with a 1.02 mm (0.040 inch) segment width. The HDSP-8825 and HDSP-8835 have a clear polycarbonate lens. Mechanical considerations and

pin-out are identical among all 3 devices. The common cathode chips are addressed via 22 single-in-line pins extending from the back side of the package.

Internal Circuit Diagram^[5,6]



NOTES
5. ELEMENT LOCATION NUMBER = COMMON CATHODE NUMBER + ANODE NUMBER
FOR EXAMPLE, ELEMENT B3 IS OBTAINED BY ADDRESSING C80 AND A3
6. A' AND C' ARE ANODE AND CATHODE OF ELEMENT ZERO.

Device Pin Description

PIN LOCATION	FUNCTION
1	C0
2	A4
3	C'(6)
4	No Pin
5	C10
6	A1
7	A8
8	No Pin
9	C20
10	No Pin
11	A'(6)
12	No Pin
13	C30
14	No Pin
15	A7
16	No Pin
17	C40
18	No Pin
19	A2
20	No Pin
21	C50
22	No Pin
23	A3
24	No Pin
25	C60
26	No Pin
27	A10
28	No Pin
29	C70
30	No Pin
31	A9
32	No Pin
33	C80
34	A5
35	A6
36	No Pin
37	C90

Absolute Maximum Ratings

Parameter	HDSP-8820	HDSP-8825	HDSP-8835
Average Power per Element ($T_A = 25^\circ\text{C}$)	15 mW	20 mW	20 mW
Peak Forward Current per Element ($T_A = 25^\circ\text{C}$) ⁷ (Pulse Width $\leq 300\ \mu\text{s}$)	200 mA	150 mA	150 mA
Average Forward Current per Element ($T_A = 25^\circ\text{C}$) ⁸	7 mA	5 mA	5 mA
Operating Temperature Range	-40° to $+85^\circ\text{C}$	-40° to $+85^\circ\text{C}$	-40° to $+85^\circ\text{C}$
Storage Temperature Range	-40° to $+85^\circ\text{C}$	-40° to $+85^\circ\text{C}$	-40° to $+85^\circ\text{C}$
Reverse Voltage per Element or DP	5.0 V	5.0 V	5.0 V
Lead Solder Temperature 1.59 mm (1.16 inch) below seating plane ⁹	260°C for 3 sec.	260°C for 3 sec.	260°C for 3 sec.

Notes:

- See Figures 1 and 2 to establish pulsed operating conditions.
- Derate maximum average forward current above $T_A = 70^\circ\text{C}$ at $0.16\ \text{mA}/^\circ\text{C}/\text{Element}$ for the HDSP-8820 and $0.11\ \text{mA}/^\circ\text{C}/\text{Element}$ for the HDSP-8825 and HDSP-8835. See Figures 3 and 4.
- Clean only in water, Isopropanol, Ethanol, Freon TF or TE (or equivalent) and Genesolv DI-15 or DE-15 (or equivalent). See mechanical section of this data sheet for information on wave soldering conditions.

Electrical/Optical Characteristics at $T_A = 25^\circ\text{C}$

RED HDSP-8820

Parameter	Symbol	Units	Min.	Typ.	Max.	Test Conditions
Time averaged Luminous Intensity per Element (Unit average) ^[10]	I_V	μcd	8	20		100 mA Pk.: 1 of 110 Duty Factor
Peak Wavelength	λ_{PEAK}	nm		655		
Dominant Wavelength ^[11]	λ_d	nm		640		
Forward Voltage per Element	V_F	V		1.7	2.1	$I_F = 100\ \text{mA}$
Reverse Voltage per Element	V_R	V	3.0			$I_R = 100\ \mu\text{A}$
Temperature Coefficient V_F per Element	$\Delta V_F/^\circ\text{C}$	$\text{mV}/^\circ\text{C}$		-2.0		
Thermal Resistance LED Junction-to-Pin	$R_{\theta J-PIN}$	$^\circ\text{C}/\text{W}/\text{LED}$		700		

HIGH EFFICIENCY RED HDSP-8825

Parameter	Symbol	Units	Min.	Typ.	Max.	Test Conditions
Time averaged Luminous Intensity per Element (Unit average) ^[10]	I_V	μcd	60	175		100 mA Pk.: 1 of 110 Duty Factor
Peak Wavelength	λ_{PEAK}	nm		635		
Dominant Wavelength ^[11]	λ_d	nm		626		
Forward Voltage per Element	V_F	V		2.3	3.1	$I_F = 100\ \text{mA}$
Reverse Voltage per Element	V_R	V	3.0			$I_R = 100\ \mu\text{A}$
Temperature Coefficient V_F per Element	$\Delta V_F/^\circ\text{C}$	$\text{mV}/^\circ\text{C}$		-2.0		
Thermal Resistance LED Junction-to-Pin	$R_{\theta J-PIN}$	$^\circ\text{C}/\text{W}/\text{LED}$		1000		

Electrical/Optical Characteristics at $T_A = 25^{\circ}\text{C}$ (continued)

HIGH PERFORMANCE GREEN HDSP-8835

Parameter	Symbol	Units	Min.	Typ.	Max.	Test Conditions
Time Averaged Luminous Intensity per Element (Unit average) ^[10]	I_V	μcd	70	175		100 mA Pk.: 1 of 110 Duty Factor
Peak Wavelength	λ_{PEAK}	nm		568		
Dominant Wavelength ^[11]	λ_d	nm		574		
Forward Voltage per Element	V_F	V		2.3	3.1	$I_F = 100\text{ mA}$
Reverse Voltage per Element	V_R	V	3.0			$I_F = 100\text{ }\mu\text{A}$
Temperature Coefficient V_F per Element	$\Delta V_F/^{\circ}\text{C}$	$\text{mV}/^{\circ}\text{C}$		-2.0		
Thermal Resistance LED Junction-to-Pin	$R\theta_{J-PIN}$	$^{\circ}\text{C}/\text{W}/\text{LED}$		1000		

Notes:

- Operation at peak currents of less than 100 mA may cause intensity mismatch. Consult factory for low current operation.
- The dominant wavelength, λ_d , is derived from the CIE chromaticity diagram and is the single wavelength which defines the color of the device.

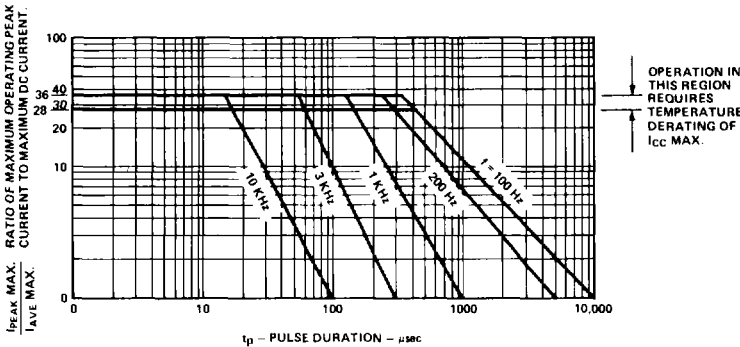


Figure 1. Maximum Tolerable Peak Current vs. Pulse Duration HDSP-8820.

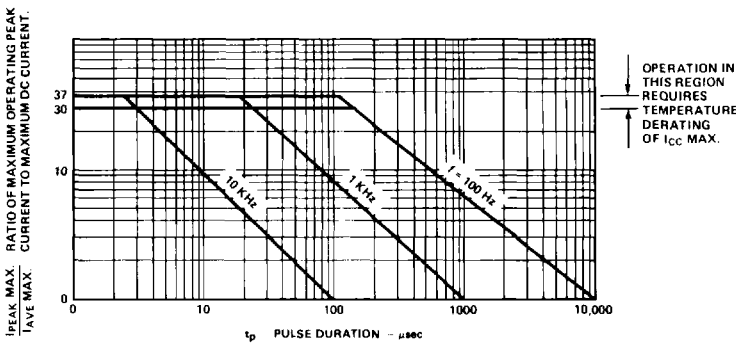


Figure 2. Maximum Tolerable Peak Current vs. Pulse Duration HDSP-8825 and HDSP-8835.

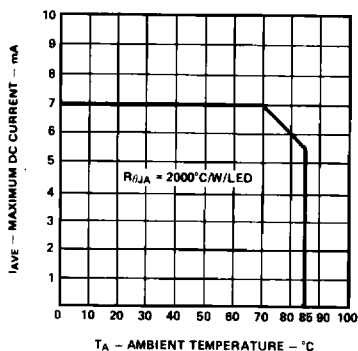


Figure 3. Maximum Allowable D.C. Current per LED vs. Ambient Temperature. Deratings Based on Maximum Allowable Thermal Resistance, LED Junction-to-Ambient on a per LED Basis. T_{JMAX} = 115°C HDSP-8820.

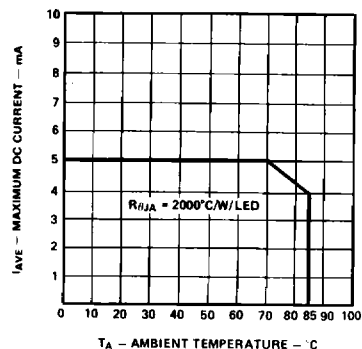


Figure 4. Maximum Allowable D.C. Current per LED vs. Ambient Temperature. Deratings Based on Maximum Allowable Thermal Resistance, LED Junction-to-Ambient on a per LED Basis. T_{JMAX} = 115°C HDSP-8825/HDSP-8835.

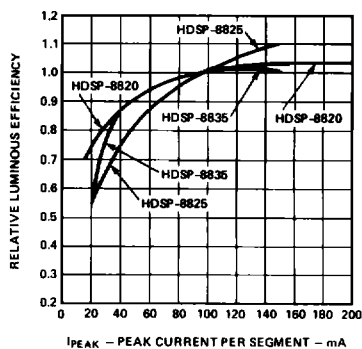


Figure 5. Relative Efficiency (Luminous Intensity per Unit Current) vs. Peak Segment Current.

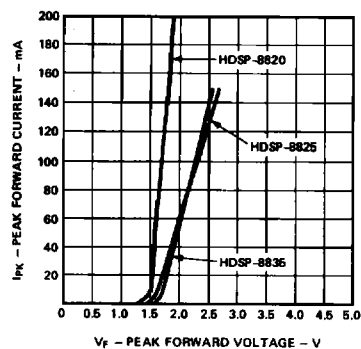


Figure 6. Forward Current vs. Forward Voltage.

For a Detailed Explanation on the Use of Data Sheet Information, See Application Note 1005.

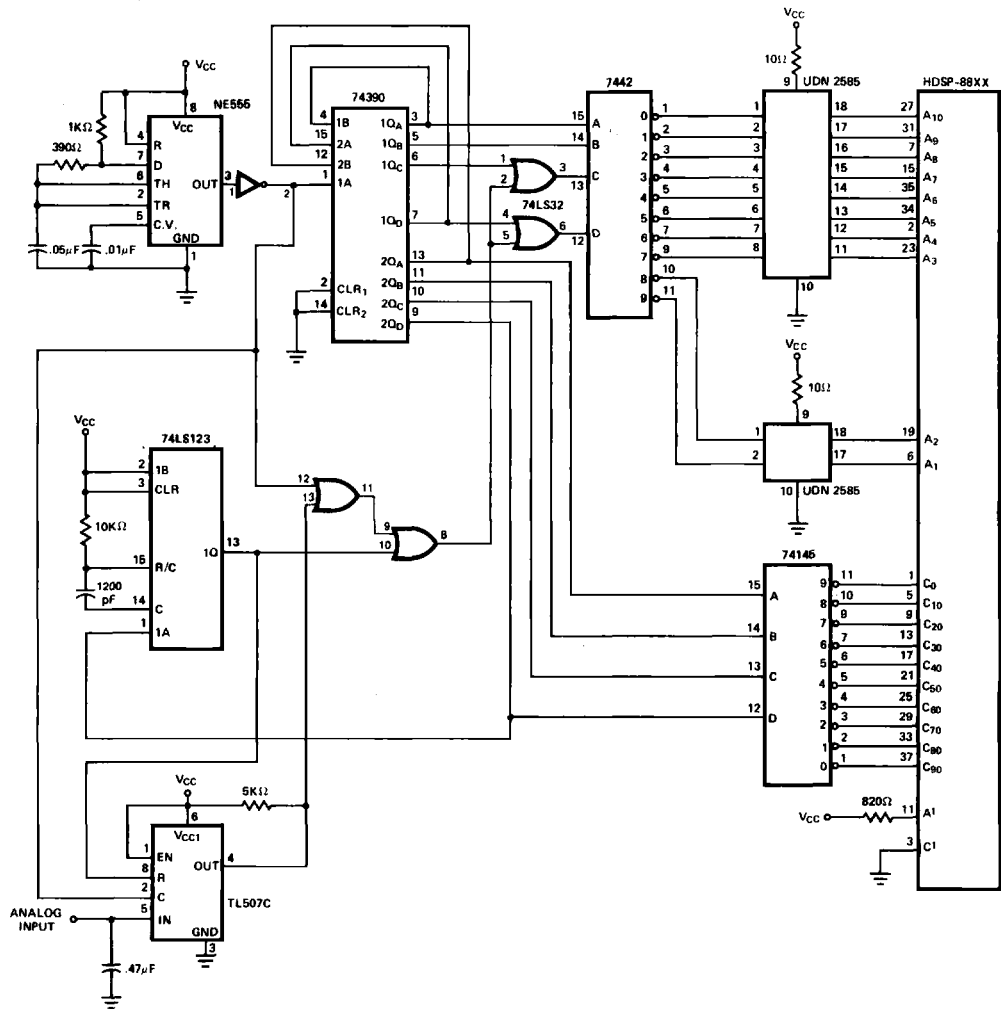


Figure 7. 101 Element Bar Graph.

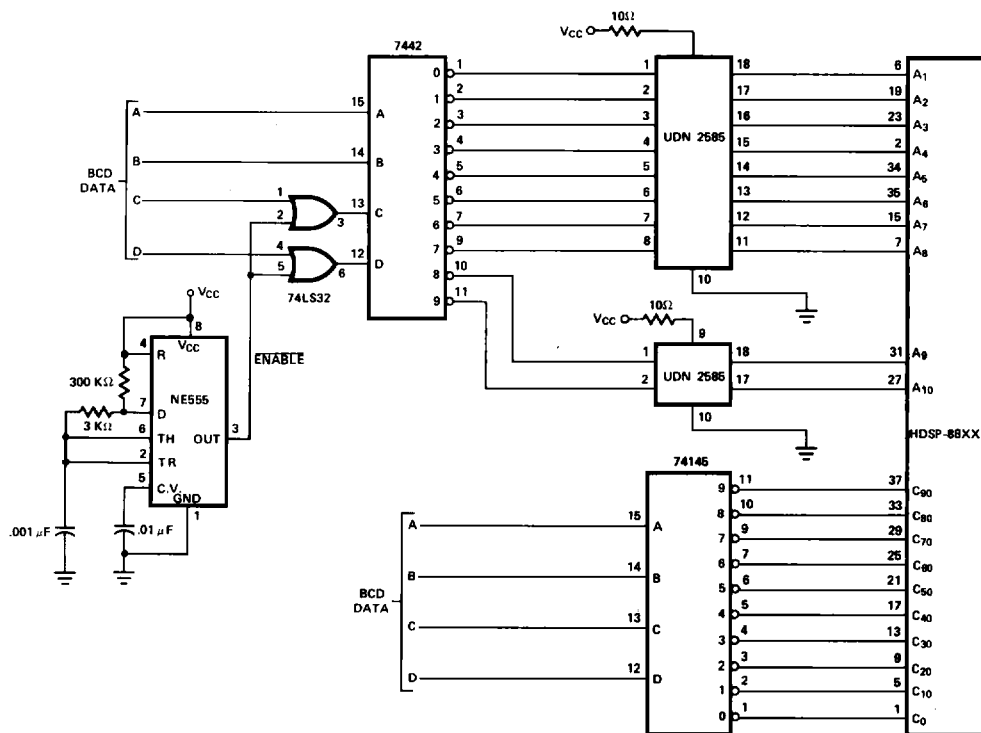


Figure 8. 100 Element Position Indicator.